

Absolute Maximum Ratings		$T_c$ = 25 °C, unless otherwise	$T_c$ = 25 °C, unless otherwise specified				
Symbol	Conditions	Values	Units				
$V_{DS}$		200	V				
I <sub>D</sub>	T <sub>s</sub> = 25 (80) °C	130 (95)	Α				
I <sub>DM</sub>	1 ms	390	Α				
$V_{GS}$		± 20	V				
V <sub>GS</sub> T <sub>vj</sub> , (T <sub>stg</sub> )		- 40 <b>+</b> 150 (125)	°C				
V <sub>isol</sub>	AC, 1 min.	2500	V				
Inverse diode							
$I_F = -I_S$		130	Α				
$I_{FM} = -I_{SM}$		390	А				

### **Power MOSFET Modules**

#### **SKM 121AR**

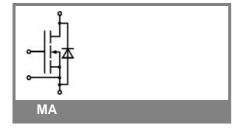
#### **Features**

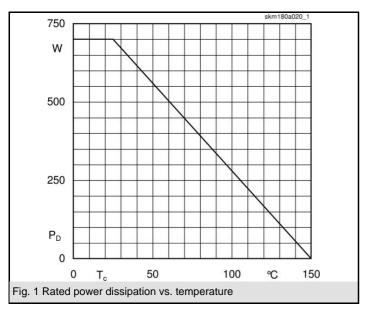
- N Channel, enhancement mode
- · Avalanche characteristics
- Short internal connections avoid oscillations
- · Isolated copper baseplates
- All electrical connections on top for easy busbaring
- Large clearance (10mm) and creepage distances (13mm)
- UL recognized, file no. E 63 532

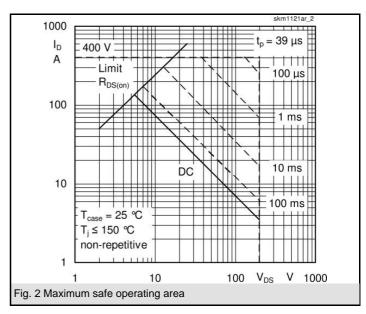
### **Typical Applications**

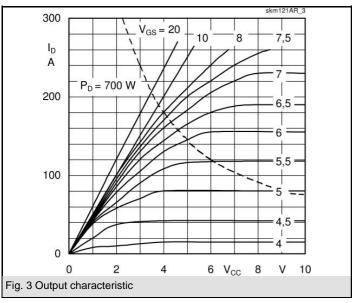
- Switched mode power supplies
- DC servo and robot drives
- DC choppers
- UPS equipment
- · Plasma cutting
- Not suitable for linear amplification

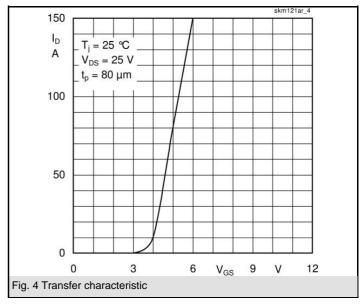
Character	ristics	T <sub>c</sub> = 25 °C, unless otherwise specified				
Symbol	Conditions	min.	typ.	max.	Units	
V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 0,25 mA	200			V	
V <sub>GS(th)</sub>	$V_{GS} = V_{DS}$ , $I_D = 1 \text{ mA}$	2,1	3	4	V	
I <sub>DSS</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 200 \text{ V},$ $T_i = 25 (125) ^{\circ}\text{C}$		50 (300)	250 (1000)	μA	
I <sub>GSS</sub>	$V'_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$		10	100	nA	
R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 80 \text{ A}$		18	20	mΩ	
g <sub>fs</sub>	$V_{DS} = 25 \text{ V}, I_{D} = 80 \text{ A}$	60	75		S	
C <sub>CHC</sub>	V <sub>GS</sub> = 0, V <sub>DS</sub> = 25 V, f = 1 MHz			160	pF	
C <sub>iss</sub>			10	13	nF	
Coss			3	4,5	nF	
C <sub>rss</sub>			0,7	1	nF	
L <sub>DS</sub>				20	nΗ	
t <sub>d(on)</sub>	V <sub>DD</sub> = 100 V, I <sub>D</sub> = 80 A,		60		ns	
tr	$V_{GS} = 10 \text{ V}, R_{G} = 3.3 \Omega$		60		ns	
$t_{d(off)}$			240		ns	
t <sub>f</sub>			70		ns	
Inverse diode						
$V_{SD}$	I <sub>F</sub> = 260 A; V <sub>GS</sub> = 0 V		1,05	1,4	V	
t <sub>rr</sub>	T <sub>i</sub> = 25 (150) °C		400		ns	
$Q_{rr}$	T <sub>j</sub> = 25 °C		4,3		μC	
I <sub>rr</sub>	$T_j = {^{\circ}C}$				Α	
Thermal characteristics						
R <sub>th(j-c)</sub>	per MOSFET			0,18	K/W	
R <sub>th(c-s)</sub>	$\rm M_{\rm s}$ , surface 10 $\mu m$ , per module			0,05	K/W	
Mechanical data						
$M_s$	to heatsink (M6)	4		5	Nm	
M <sub>t</sub>	for terminals (M5)	2,5		3,5	Nm	
W				130	g	

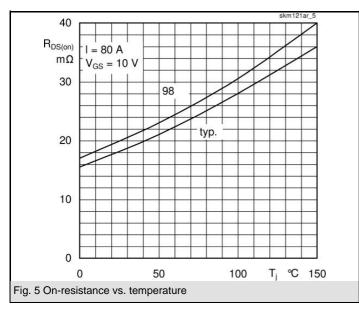


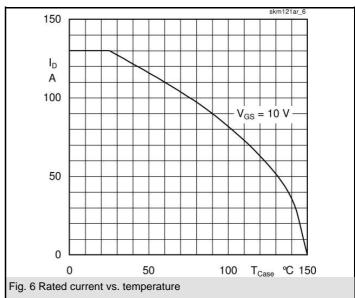


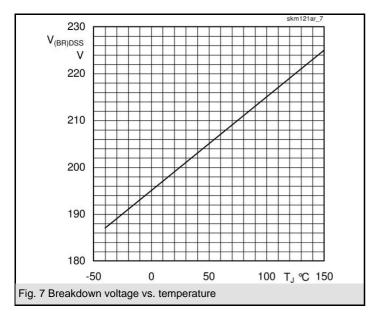


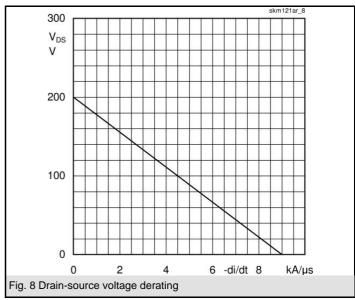


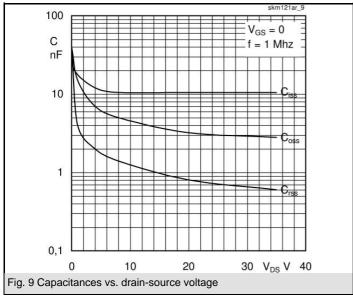


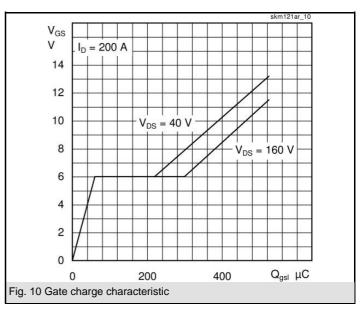


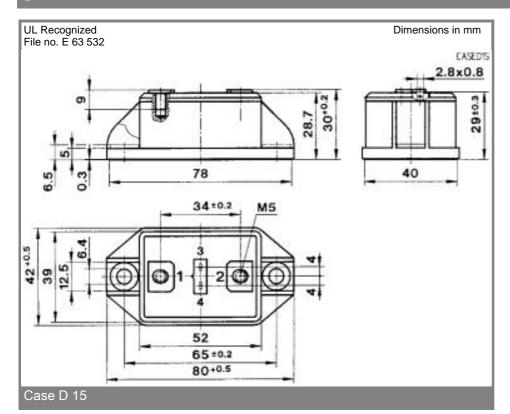


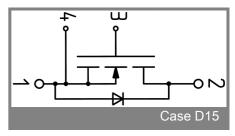












This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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